

CY7C0850AV/CY7C0851AV CY7C0852AV/CY7C0853AV

FLEx36™ 3.3V 32K/64K/128K/256K x 36 Synchronous Dual-Port RAM

Features

- True dual-ported memory cells that allow simultaneous access of the same memory location
- Synchronous pipelined operation
- Organization of 1-Mbit, 2-Mbit, 4-Mbit and 9-Mbit devices
- · Pipelined output mode allows fast operation
- 0.18-micron CMOS for optimum speed and power
- High-speed clock to data access
- 3.3V low power
 - Active as low as 225 mA (typ)
 - Standby as low as 55 mA (typ)
- Mailbox function for message passing
- Global master reset
- · Separate byte enables on both ports
- · Commercial and industrial temperature ranges
- IEEE 1149.1-compatible JTAG boundary scan
- 172-ball FBGA (1 mm pitch) (15 mm × 15 mm)
- 176-pin TQFP (24 mm × 24 mm × 1.4 mm)
- Counter wrap around control
- Internal mask register controls counter wrap-around
- Counter-interrupt flags to indicate wrap-around
- Memory block retransmit operation
- · Counter readback on address lines
- · Mask register readback on address lines
- Dual Chip Enables on both ports for easy depth expansion

Table 1. Product Selection Guide

Functional Description

The FLEx36[™] family includes 1M, 2M, 4M and 9M pipelined, synchronous, true dual-port static RAMs that are high-speed, low-power 3.3V CMOS. Two ports are provided, permitting independent, simultaneous access to any location in memory. The result of writing to the same location by more than one port at the same time is undefined. Registers on control, address, and data lines allow for minimal set-up and hold time.

During a Read operation, data is registered for decreased cycle time. Each port contains a burst counter on the input address register. After externally loading the counter with the initial address, the counter will increment the address internally (more details to follow). The internal Write pulse width is independent of the duration of the R/W input signal. The internal Write pulse is self-timed to allow the shortest possible cycle times.

A HIGH on $\overline{CE0}$ or LOW on CE1 for one clock cycle will power down the internal circuitry to reduce the static power consumption. One cycle with chip enables asserted is required to reactivate the outputs.

Additional features include: readback of burst-counter internal address value on address lines, counter-mask registers to control the counter wrap-around, counter interrupt (CNTINT) flags, readback of mask register value on address lines, retransmit functionality, interrupt flags for message passing, JTAG for boundary scan, and asynchronous Master Reset (MRST).

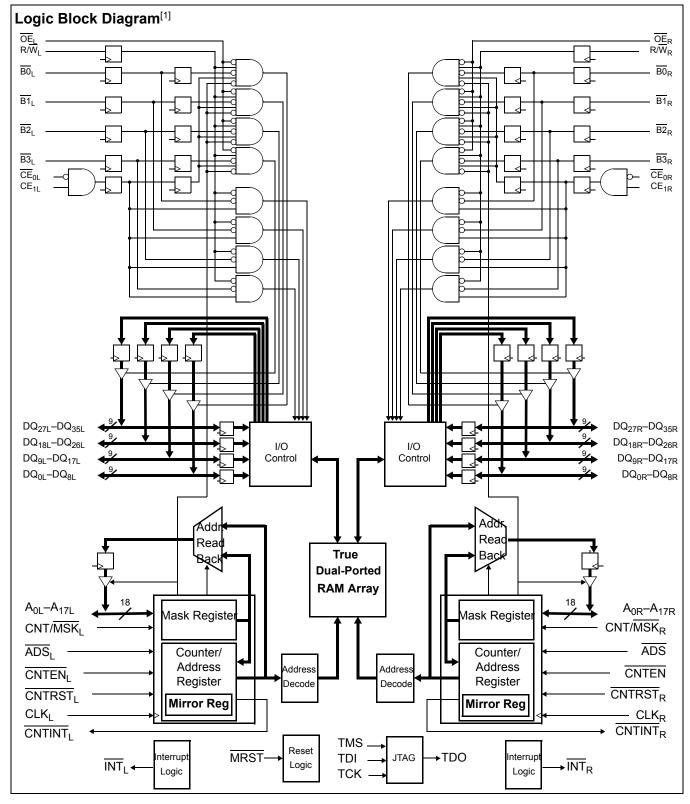
The CY7C0853A device in this family has limited features. Please see See "Address Counter and Mask Register Operations^[10]" on page 8. for details.

Density	1-Mbit (32K x 36)	2-Mbit (64K x 36)	4-Mbit (128K x 36)	9-Mbit (256K x 36)
Part Number	CY7C0850AV	CY7C0851AV	CY7C0852AV	CY7C0853AV
Max. Speed (MHz)	167	167	167	133
Max. Access Time - Clock to Data (ns)	4.0	4.0	4.0	4.7
Typical operating current (mA)	225	225	225	270
Package	176TQFP 172FBGA	176TQFP 172FBGA	176TQFP 172FBGA	172FBGA

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CY7C0850AV/CY7C0851AV CY7C0852AV/CY7C0853AV



Note:

1. 9M device has 18 address bits, 4M device has 17 address bits, 2M device has 16 address bits, and 1M device has 15 address bits.



Pin Configurations

172-ball BGA **Top View**

	1	2	3	4	5	6	7	8	9	10	11	12	13	14
Α	DQ32L	DQ30L	CNTINTL	VSS	DQ13L	VDD	DQ11L	DQ11R	VDD	DQ13R	VSS	CNTINTR	DQ30R	DQ32R
в	A0L	DQ33L	DQ29L	DQ17L	DQ14L	DQ12L	DQ9L	DQ9R	DQ12R	DQ14R	DQ17R	DQ29R	DQ33R	A0R
С	NC	A1L	DQ31L	DQ27L	INTL	DQ15L	DQ10L	DQ10R	DQ15R	INTR	DQ27R	DQ31R	A1R	NC
D	A2L	A3L	DQ35L	DQ34L	DQ28L	DQ16L	VSS	VSS	DQ16R	DQ28R	DQ34R	DQ35R	A3R	A2R
Е	A4L	A5L	CE1L	BOL	VDD	VSS			VDD	VDD	BOR	CE1R	A5R	A4R
F	VDD	A6L	A7L	B1L	VDD					VSS	B1R	A7R	A6R	VDD
G	OEL	B2L	B3L	CEOL		CY7C0850V CY7C0851V					CE0R	B3R	B2R	OER
н	VSS	R/WL	A8L	CLKL			CY7C	0852V			CLKR	A8R	R/WR	VSS
J	A9L	A10L	VSS	ADSL	VSS					VDD	ADSR	MRST	A10R	A9R
κ	A11L	A12L	A15L ^[2]	CNTRSTL	VDD	VDD			VSS	VDD	CNTRSTR	A15R ^[2]	A12R	A11R
L	CNT/MSKL	A13L	CNTENL	DQ26L	DQ25L	DQ19L	VSS	VSS	DQ19R	DQ25R	DQ26R	CNTENR	A13R	CNT/MSKR
м	A16L ^[2]	A14L	DQ22L	DQ18L	TDI	DQ7L	DQ2L	DQ2R	DQ7R	тск	DQ18R	DQ22R	A14R	A16R ^[2]
Ν	DQ24L	DQ20L	DQ8L	DQ6L	DQ5L	DQ3L	DQ0L	DQ0R	DQ3R	DQ5R	DQ6R	DQ8R	DQ20R	DQ24R
Ρ	DQ23L	DQ21L	TDO	VSS	DQ4L	VDD	DQ1L	DQ1R	VDD	DQ4R	VSS	TMS	DQ21R	DQ23R

Note: 2. For CY7C0851V, pins M1 and M14 are NC. For CY7C0850V, pins K3, K12 M1, and M14 are NC



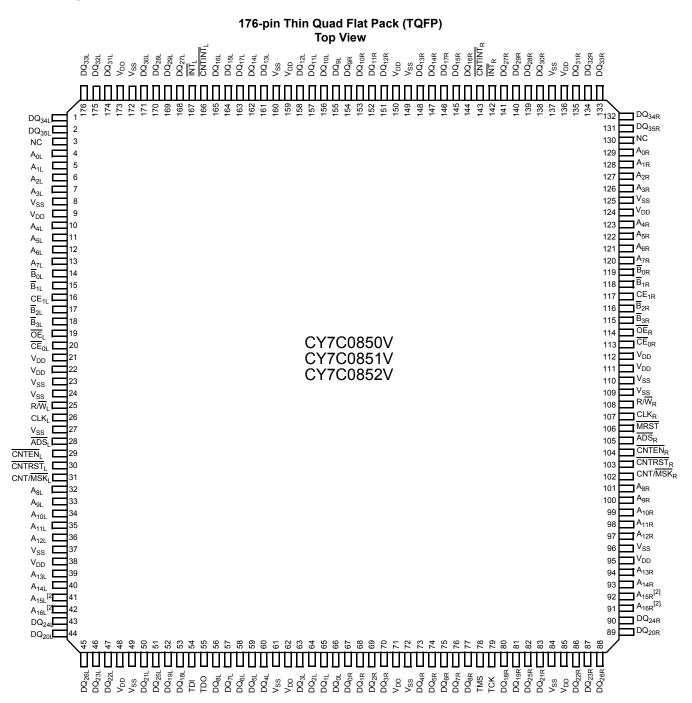
Pin Configurations (continued)

172-ball BGA Top View

	1	2	3	4	5	6	7	8	9	10	11	12	13	14
Α	DQ32L	DQ30L	NC	VSS	DQ13L	VDD	DQ11L	DQ11R	VDD	DQ13R	VSS	NC	DQ30R	DQ32R
в	A0L	DQ33L	DQ29L	DQ17L	DQ14L	DQ12L	DQ9L	DQ9R	DQ12R	DQ14R	DQ17R	DQ29R	DQ33R	A0R
С	A17L	A1L	DQ31L	DQ27L	INTL	DQ15L	DQ10L	DQ10R	DQ15R	INTR	DQ27R	DQ31R	A1R	A17R
D	A2L	A3L	DQ35L	DQ34L	DQ28L	DQ16L	VSS	VSS	DQ16R	DQ28R	DQ34R	DQ35R	A3R	A2R
Е	A4L	A5L	VDD	B0L	VDD	VSS			VDD	VDD	B0R	VDD	A5R	A4R
F	VDD	A6L	A7L	B1L	VDD					VSS	B1R	A7R	A6R	VDD
G	OEL	B2L	B3L	VSS		(CY7C	0853\	/		VSS	B3R	B2R	OER
н	VSS	R/WL	A8L	CLKL							CLKR	A8R	R/WR	VSS
J	A9L	A10L	VSS	VSS	VSS					VDD	VSS	MRST	A10R	A9R
к	A11L	A12L	A15L	VDD	VDD	VDD			VSS	VDD	VDD	A15R	A12R	A11R
L	VDD	A13L	VSS	DQ26L	DQ25L	DQ19L	VSS	VSS	DQ19R	DQ25R	DQ26R	VSS	A13R	VDD
м	A16L	A14L	DQ22L	DQ18L	TDI	DQ7L	DQ2L	DQ2R	DQ7R	тск	DQ18R	DQ22R	A14R	A16R
N	DQ24L	DQ20L	DQ8L	DQ6L	DQ5L	DQ3L	DQ0L	DQ0R	DQ3R	DQ5R	DQ6R	DQ8R	DQ20R	DQ24R
Ρ	DQ23L	DQ21L	TDO	VSS	DQ4L	VDD	DQ1L	DQ1R	VDD	DQ4R	VSS	TMS	DQ21R	DQ23R



Pin Configurations (continued)





Pin Definitions

Left Port	Right Port	Description
A _{0L} -A _{17L} ^[1]	A _{0R} -A _{17R} ^[1]	Address Inputs.
ADS _L ^[3]	ADS _R ^[3]	Address Strobe Input. Used as an address qualifier. This signal should be asserted LOW for the part using the externally supplied address on the address pins and for loading this address into the burst address counter.
CE0 _L ^[3]	CE0 _R ^[3]	Active LOW Chip Enable Input.
CE1 _L ^[3]	CE1 _R ^[3]	Active HIGH Chip Enable Input.
CLKL	CLK _R	Clock Signal. Maximum clock input rate is f _{MAX} .
CNTEN _L ^[3]	CNTEN _R ^[3]	Counter Enable Input . Asserting this signal LOW increments the burst address counter of its respective port on each rising edge of CLK. The increment is disabled if ADS or CNTRST are asserted LOW.
CNTRST _L ^[3]	CNTRST _R ^[3]	Counter Reset Input . Asserting this signal L <u>OW reset</u> s to zero the unmasked portion of the <u>burst ad</u> dress counter of its respective port. CNTRST is not disabled by asserting ADS or CNTEN.
CNT/MSK _L ^[3]	CNT/MSK _R ^[3]	Address Counter Mask Register Enable Input. Asserting this signal LOW enables access to the mask register. When tied HIGH, the mask register is not accessible and the address counter operations are enabled based on the status of the counter control signals.
DQ _{0L} –DQ _{35L}	DQ _{0R} -DQ _{35R}	Data Bus Input/Output.
OEL	OE _R	Output Enable Input . This asynchronous signal must be asserted LOW to enable the DQ data pins during Read operations.
INTL	INTR	Mailbox Interrupt Flag Output . The mailbox permits communications between ports. The upper two memory locations can be used for message passing. INT _L is asserted LOW when the right port writes to the mailbox location of the left port, and vice versa. An interrupt to a port is deasserted HIGH when it reads the contents of its mailbox.
CNTINT _L ^[3]	CNTINT _R ^[3]	Counter Interrupt Output . This pin is asserted LOW when the unmasked portion of the counter is incremented to all "1s."
R/WL	R/W _R	Read/Write Enable Input . Assert this pin LOW to write to, or HIGH to Read from the dual port memory array.
B _{0L} –B _{3L}	B _{0R} –B _{3R}	Byte Select Inputs. Asserting these signals enables Read and Write operations to the corresponding bytes of the memory array.
MRST		Master Reset Input. MRST is an asynchronous input signal and affects both ports. Asserting MRST LOW performs all of the reset functions as described in the text. A MRST operation is required at power-up.
TMS		JTAG Test Mode Select Input . It controls the advance of JTAG TAP state machine. State machine transitions occur on the rising edge of TCK.
TDI		JTAG Test Data Input. Data on the TDI input will be shifted serially into selected registers.
тск		JTAG Test Clock Input.
TDO		JTAG Test Data Output . TDO transitions occur on the falling edge of TCK. TDO is normally three-stated except when captured data is shifted out of the JTAG TAP.
V _{SS}		Ground Inputs.
V _{DD}		Power Inputs.

Note: 3. These pins are not available for CY7C0853AV device.



Master Reset

The FLEx36 family devices undergo a complete reset by taking its MRST input LOW. The MRST input can switch asynchronously to the clocks. The MRST initializes the internal burst counters to zero, and the counter mask registers to all ones (completely unmasked). The MRST also forces the Mailbox Interrupt (INT) flags and the Counter Interrupt (CNTINT) flags HIGH. The MRST must be performed on the FLEx36 family devices after power-up.

Mailbox Interrupts

The upper two memory locations may be used for message passing and permit communications between ports. Table 2 shows the interrupt operation for both ports of CY7C0853AV. The highest memory location, 3FFFF is the mailbox for the right port and 3FFFE is the mailbox for the left port. Table 2

shows that in order to set the INT_R flag, a Write operation by the left port to address 3FFFF will assert INT_R LOW. At least one byte has to be active for a Write to generate an interrupt. A valid Read of the 3FFFF location by the right port will reset $\mathsf{INT}_\mathsf{R}\,\mathsf{HIGH}.$ At least one byte has to be active in order for a Read to reset the interrupt. When one port Writes to the other port's mailbox, the INT of the port that the mailbox belongs to is asserted LOW. The INT is reset when the owner (port) of the mailbox Reads the contents of the mailbox. The interrupt flag is set in a flow-thru mode (i.e., it follows the clock edge of the writing port). Also, the flag is reset in a flow-thru mode (i.e., it follows the clock edge of the reading port).

Each port can read the other port's mailbox without resetting the interrupt. And each port can write to its own mailbox without setting the interrupt. If an application does not require message passing, INT pins should be left open.

		Left Port			Right Port				
Function	R/W	CEL	A _{0L-17L}		R/W _R	CER	A _{0R-17R}	INT _R	
Set Right INT _R Flag	L	L	3FFFF	Х	Х	Х	Х	L	
Reset Right INT _R Flag	Х	Х	Х	Х	Н	L	3FFFF	Н	
Set Left INT _L Flag	Х	Х	Х	L	L	L	3FFFE	Х	
Reset Left INT _L Flag	Н	L	3FFFE	Н	Х	Х	Х	Х	

Table 2. Interrupt Operation Example^[1, 4, 5, 6, 7]

CLK	MRST	CNT/MSK	CNTRST	ADS	CNTEN	Operation	Description
Х	L	Х	Х	Х	Х	Master Reset	Reset address counter to all 0s and mask register to all 1s.
	Н	Н	L	Х	Х	Counter Reset	Reset counter unmasked portion to all 0s.
	Н	Н	Н	L	L	Counter Load	Load counter with external address value presented on address lines.
	Н	Н	Н	L	Н	Counter Readback	Read out counter internal value on address lines.
	Н	Н	Н	Н	L	Counter Increment	Internally increment address counter value.
	Н	Н	Н	Н	Н	Counter Hold	Constantly hold the address value for multiple clock cycles.
	Н	L	L	Х	Х	Mask Reset	Reset mask register to all 1s.
	Н	L	Н	L	L	Mask Load	Load mask register with value presented on the address lines.
	Н	L	Н	L	Н	Mask Readback	Read out mask register value on address lines.
5	Н	L	Н	Н	Х	Reserved	Operation undefined

Table 3. Address Counter and Counter-Mask Register Control Operation (Any Port)^[8, 9]

Notes:

4. \overline{CE} is internal signal. \overline{CE} = LOW if \overline{CE}_0 = LOW and \overline{CE}_1 = HIGH. For a single Read operation, CE only needs to be asserted once at the rising edge of the CLK and can be deasserted after that. Data will be out after the following CLK edge and will be three-stated after the next CLK edge.

OE is "Don't Care" for mailbox operation.
 At least one of B0, B1, B2, or B3 must be LOW.

7. A16x is a NC for CY7C0851AV, therefore the Interrupt Addresses are FFFF and EFFF; A16x and A15x are NC for CY7C0850AV, therefore the Interrupt Addresses are 7FFF and 6FFF.

8. "X" = "Don't Care," "H" = HIGH, "L" = LOW.

9. Counter operation and mask register operation is independent of chip enables.



Address Counter and Mask Register Operations^[10]

This section describes the features only apply to CY7C0850AV/CY7C0851AV/CY7C0852AV devices, but not to the CY7C0853AV device. Each port of these devices has a programmable burst address counter. The burst counter contains three registers: a counter register, a mask register, and a mirror register.

The **counter register** contains the address used to access the RAM array. It is changed only by the C<u>ounter</u> Load, Increment, Counter Reset, and by master reset (MRST) operations.

The **mask register** value affects the Increment and Counter Reset operations by preventing the corresponding bits of the counter register <u>from changing</u>. It also affects the counter interrupt output (CNTINT). The mask register is changed only <u>by the</u> Mask Load and Mask Reset operations, and by the MRST. The mask register defines the counting range of the counter register. It divides the counter register into two regions: zero or more "0s" in the most significant bits define the masked region, one or more "1s" in the least significant bits define the unmasked region. Bit 0 may also be "0," masking the least significant counter bit and causing the counter to increment by two instead of one.

The mirror register is used to reload the counter register on increment operations (see "retransmit," below). It always contains the value last loaded into the counter register, and is changed only by the Counter Load operation, and by the MRST.

Table 3 summarizes the operation of <u>these</u> registers and the required input control signals. The MRST control signal is asynchronous. All the other control signals in Table 3 (CNT/MSK, CNTRST, ADS, CNTEN) are synchronized to the port's CLK. All these counter and mask <u>ope</u>rations are independent of the port's chip enable inputs (CE0 and CE1).

Counter enable (CNTEN) inputs are provided to stall the operation of the address input and utilize the internal address generated by the internal counter for fast, interleaved memory applications. A port's burst counter is loaded when the port's address strobe (ADS) and CNTEN signals are LOW. When the port's CNTEN is asserted and the ADS is deasserted, the address counter will increment on each LOW to HIGH transition of that port's clock signal. This will Read/Write one word from/into each successive address the entire memory array, and will loop back to the start. Counter reset (CNTRST) is used to reset the unmasked portion of the burst counter to 0s. A counter-mask register is used to control the counter wrap.

Counter Reset Operation

All unmasked bits of the counter are reset to "0." All masked bits remain unchanged. The mirror register is loaded with the value of the burst counter. A Mask Reset followed by a Counter Reset will reset the counter and mirror registers to 00000, as will master reset (MRST).

Counter Load Operation

The address counter and mirror registers are both loaded with the address value presented at the address lines.

Counter Readback Operation

The internal value of the counter register can be read out on the address lines. Readback is pipelined; the address will be valid t_{CA2} after the next rising edge of the port's clock. If address readback occurs while the port is enabled (CE0 LOW and CE1 HIGH), the data lines (DQs) will be three-stated. *Figure 1* shows a block diagram of the operation.

Counter Increment Operation

Once the address counter register is initially loaded with an external address, the counter can internally increment the address value, potentially addressing the entire memory array. Only the unmasked bits of the counter register are incremented. The corresponding bit in the mask register must be a "1" for a counter bit to change. The counter register is incremented by 1 if the least significant bit is unmasked, and by 2 if it is masked. If all unmasked bits are "1," the next increment will wrap the counter back to the initially loaded value. If an Increment results in all the unmasked bits of the counter being "1s," a counter interrupt flag (CNTINT) is asserted. The next Increment will return the counter register to its initial value, which was stored in the mirror register. The counter address can instead be forced to loop to 00000 by externally connecting CNTINT to CNTRST.^[11] An increment that results in one or more of the unmasked bits of the counter being "0" will deassert the counter interrupt flag. The example in *Figure 2* shows the counter mask register loaded with a mask value of 0003Fh unmasking the first 6 bits with bit "0" as the LSB and bit "16" as the MSB. The maximum value the mask register can be loaded with is 1FFFFh. Setting the mask register to this value allows the counter to access the entire memory space. The address counter is then loaded with an initial value of 8h. The base address bits (in this case, the 6th address through the 16th address) are loaded with an address value but do not increment once the counter is configured for increment operation. The counter address will start at address 8h. The counter will increment its internal address value till it reaches the mask register value of 3Fh. The counter wraps around the memory block to location 8h at the next count. CNTINT is issued when the counter reaches its maximum value.

Counter Hold Operation

The value of all three registers can be constantly maintained unchanged for an unlimited number of clock cycles. Such operation is useful in applications where wait states are needed, or when address is available a few cycles ahead of data in a shared bus interface.

Counter Interrupt

The counter interrupt (CNTINT) is asserted LOW when an increment operation results in the unmasked portion of the counter register being all "1s." It is deasserted HIGH when an Increment operation results in any other value. It is also de-asserted by Counter Reset, Counter Load, Mask Reset and Mask Load operations, and by MRST.

Notes:

^{10.} This section describes the CY7C0852V, which have 17 address bits and a maximum address value of 1FFFF. The CY7C0851V has 16 address bits, register lengths of 16 bits, and a maximum address value of FFFF. The CY7C0850V has 15 address bits, register lengths of 15 bits, and a maximum address value of 7FFF 11. CNTINT and CNTRST specs are guaranteed by design to operate properly at speed grade operating frequency when tied together.



Retransmit

Retransmit is a feature that allows the Read of a block of memory more than once without the need to reload the initial address. This eliminates the need for external logic to store and route data. It also reduces the complexity of the system design and saves board space. An internal "mirror register" is used to store the initially loaded address counter value. When the counter unmasked portion reaches its maximum value set by the mask register, it wraps back to the initial value stored in this "mirror register." If the counter is continuously configured in increment mode, it increments again to its maximum value and wraps back to the value initially stored into the "mirror register." Thus, the repeated access of the same data is allowed without the need for any external logic.

Mask Reset Operation

The mask register is reset to all <u>"1s,"</u> which unmasks every bit of the counter. Master reset (MRST) also resets the mask register to all "1s."

Mask Load Operation

The mask register is loaded with the address value presented at the address lines. Not all values permit correct increment operations. Permitted values are of the form $2^n - 1$ or $2^n - 2$. From the most significant bit to the least significant bit, permitted values have zero or more "0s," one or more "1s," or one "0." Thus 1FFFF, 003FE, and 00001 are permitted values, but 1F0FF, 003FC, and 00000 are not.

Mask Readback Operation

The internal value of the mask register can be read out on the address lines. Readback is pipelined; the address will be valid t_{CM2} after the next rising edge of the port's clock. If mask readback occurs while the port is enabled (CE0 LOW and CE1 HIGH), the data lines (DQs) will be three-stated. *Figure 1* shows a block diagram of the operation.

Counting by Two

When the least significant bit of the mask register is "0," the counter increments by two. This may be used to connect the CY7C0850AV/CY7C0851AV/CY7C0852AV as a 72-bit single port SRAM in which the counter of one port counts even addresses and the counter of the other port counts odd addresses. This even-odd address scheme stores one half of the 72-bit data in even memory locations, and the other half in odd memory locations.



CY7C0850AV/CY7C0851AV CY7C0852AV/CY7C0853AV

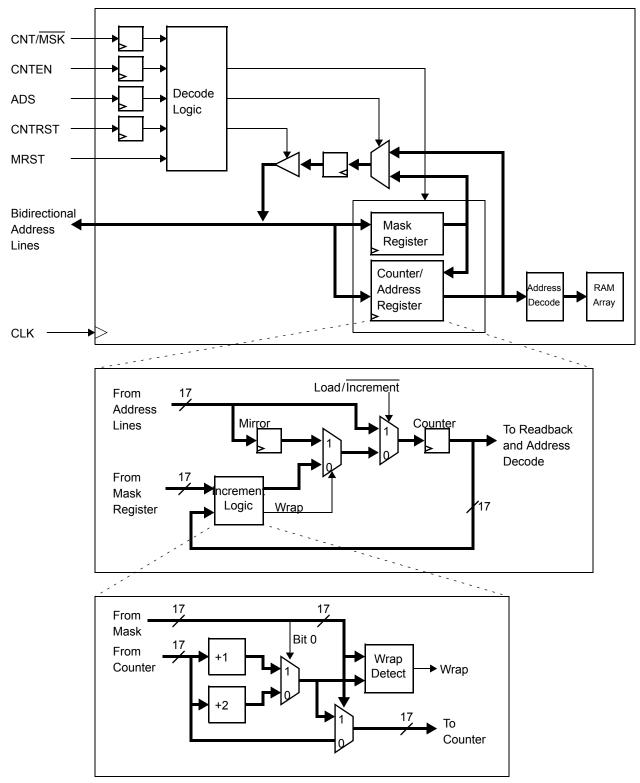


Figure 1. Counter, Mask, and Mirror Logic Block Diagram^[1]



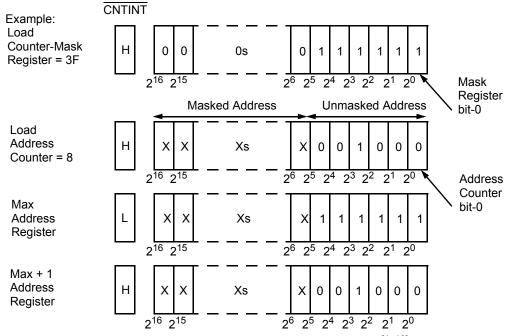


Figure 2. Programmable Counter-Mask Register Operation^[1, 12]

IEEE 1149.1 Serial Boundary Scan (JTAG)^[13]

The CY7C0850AV/CY7C0851AV/CY7C0852AV/CY7C0853AV incorporates an IEEE 1149.1 serial boundary scan test access port (TAP). The TAP controller functions in a manner that does not conflict with the operation of other devices using 1149.1-compliant TAPs. The TAP operates using JEDEC-standard 3.3V I/O logic levels. It is composed of three input connections and one output connection required by the test logic defined by the standard.

Performing a TAP Reset

A reset is performed by forcing TMS HIGH (V_{DD}) for five rising edges of TCK. This reset does not affect the operation of the

Table 4. Identification Register Definitions

devices, and <u>may</u> be performed while the devices are operating. An MRST must be performed on the devices after power-up.

Performing a Pause/Restart

When a SHIFT-DR PAUSE-DR SHIFT-DR is performed the scan chain will output the next bit in the chain twice. For example, if the value expected from the chain is 1010101, the device will output a 11010101. This extra bit will cause some testers to report an erroneous failure for the devices in a scan test. Therefore the tester should be configured to never enter the PAUSE-DR state.

Instruction Field	Value	Description
Revision Number (31:28)	0h	Reserved for version number.
Cypress Device ID (27:12)	C001h	Defines Cypress part number for the CY7C0851AV
	C002h	Defines Cypress part number for the CY7C0852AV and CY7C0853AV
	C092h	Defines Cypress part number for the CY7C0850AV
Cypress JEDEC ID (11:1)	034h	Allows unique identification of the DP family device vendor.
ID Register Presence (0)	1	Indicates the presence of an ID register.

Notes:

12. The "X" in this diagram represents the counter upper bits.

13. Boundary scan is IEEE 1149.1-compatible. See "Performing a Pause/Restart" for deviation from strict 1149.1 compliance



CY7C0850AV/CY7C0851AV CY7C0852AV/CY7C0853AV

Table 5. Scan Registers Sizes

Register Name	Bit Size
Instruction	4
Bypass	1
Identification	32
Boundary Scan	n ^[14]

Table 6. Instruction Identification Codes

Instruction	Code	Description
EXTEST	0000	Captures the Input/Output ring contents. Places the BSR between the TDI and TDO.
BYPASS	1111	Places the BYR between TDI and TDO.
IDCODE	1011	Loads the IDR with the vendor ID code and places the register between TDI and TDO.
HIGHZ	0111	Places BYR between TDI and TDO. Forces all CY7C0851AV/CY7C0852AV/ CY7C0853AV output drivers to a High-Z state.
CLAMP	0100	Controls boundary to 1/0. Places BYR between TDI and TDO.
SAMPLE/PRELOAD	1000	Captures the input/output ring contents. Places BSR between TDI and TDO.
NBSRST	1100	Resets the non-boundary scan logic. Places BYR between TDI and TDO.
RESERVED	All other codes	Other combinations are reserved. Do not use other than the above.

Note:

14. See details in the device BSDL files.



CY7C0850AV/CY7C0851AV CY7C0852AV/CY7C0853AV

Maximum Ratings^[15]

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–65°C to + 150°C
Ambient Temperature with Power Applied	–55°C to + 125°C
Supply Voltage to Ground Potential	
DC Voltage Applied to Outputs in High-Z State	–0.5V to V _{DD} + 0.5V

DC Input Voltage0.5V to	V _{DD} + 0.5V ^[16]
Output Current into Outputs (LOW)	20 mA
Static Discharge Voltage (JEDEC JESD22-A114-2000B)	> 2000V
Latch-up Current	> 200 mA

Operating Range

Range	Ambient Temperature	V _{DD}
Commercial	0°C to +70°C	3.3V ± 165 mV
Industrial	–40°C to +85°C	3.3V ± 165 mV

Electrical Characteristics Over the Operating Range

				-167			-133			-100		
Parameter	Description		Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
V _{OH}	Output HIGH Voltage (V _{DD} = Min., I _{OH} = –4.0 mA)		2.4			2.4			2.4			V
V _{OL}	Output LOW Voltage (V _{DD} = Min., I _{OL} = +4.0 mA)				0.4			0.4			0.4	V
V _{IH}	Input HIGH Voltage		2.0			2.0			2.0			V
V _{IL}	Input LOW Voltage				0.8			0.8			0.8	V
I _{OZ}	Output Leakage Current		-10		10	-10		10	-10		10	μA
I _{IX1}	Input Leakage Current Except TDI, T	TMS, MRST	-10		10	-10		10	-10		10	μA
I _{IX2}	Input Leakage Current TDI, TMS, MF	RST	-0.1		1.0	-0.1		1.0	-0.1		1.0	mA
I _{CC}	$(V_{DD} = Max., I_{OUT} = 0 mA),$ CY	Y7C0850AV Y7C0851AV Y7C0852AV		225	300		225	300				mA
	CY	Y7C0853AV					270	400		200	310	
I _{SB1} ^[18]	$\frac{Standby Current}{CE_L and CE_R} \geq V_{IH}, f = f_{MAX}$	vel)		90	115		90	115		90	115	mA
I _{SB2} ^[18]	$\frac{Standby Current}{CE_L} (One Port TTL Level CE_L CE_R \ge V_{IH}, f = f_{MAX}$	el)		160	210		160	210		160	210	mA
I _{SB3} ^[18]	Standby Current (Both Ports CMOS CEL and $CE_R \ge V_{DD} - 0.2V$, f = 0	Level)		55	75		55	75		55	75	mA
I _{SB4} ^[18]	$\frac{Sta}{CE_L} CE_R \ge V_{IH}, f = f_{MAX}$	evel)		160	210		160	210		160	210	mA
I _{SB5}	Operating Current (V _{DD} = Max, I _{OUT} = 0 mA, f = 0) Outputs Disabled	Y7C0853AV					70	100		70	100	mA

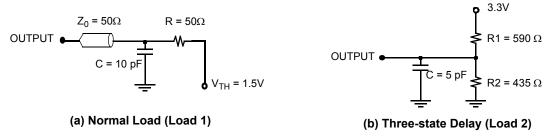
Capacitance [17]

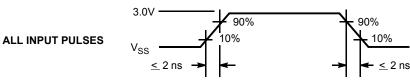
Part Number	Parameter	Description	Test Conditions	Max.	Unit
CY7C0850AV/7C0851AV	C _{IN}	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	13	pF
/CY7C0852AV	C _{OUT}	Output Capacitance	V _{DD} = 3.3V	10	pF
CY7C0853AV	C _{IN}	Input Capacitance		22	pF
	C _{OUT}	Output Capacitance		20	pF

Note: 15. The voltage on any input or I/O pin can not exceed the power pin during power-up. 16. Pulse width < 20 ns. 17. C_{OUT} also references C_{I/O}. 18. I_{SB1}, I_{SB2}, I_{SB3} and I_{SB4} are not applicable for CY7C0853AV because it can not be powered down by using chip enable pins.



AC Test Load and Waveforms





$\label{eq:switching Characteristics} Switching Characteristics \mbox{ Over the Operating Range}$

		-1	67		-1	33		-1	00	
		CY7C)850AV)851AV)852AV	CY7C0)850AV)851AV)852AV	CY7C)853AV	CY7C0)853AV	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
f _{MAX2}	Maximum Operating Frequency		167		133		133		100	MHz
t _{CYC2}	Clock Cycle Time	6.0		7.5		7.5		10.0		ns
t _{CH2}	Clock HIGH Time	2.7		3.0		3.0		4.0		ns
t _{CL2}	Clock LOW Time	2.7		3.0		3.0		4.0		ns
t _R ^[19]	Clock Rise Time		2.0		2.0		2.0		3.0	ns
t _F ^[19]	Clock Fall Time		2.0		2.0		2.0		3.0	ns
t _{SA}	Address Set-up Time	2.3		2.5		2.5		3.0		ns
t _{HA}	Address Hold Time	0.6		0.6		0.6		0.6		ns
t _{SB}	Byte Select Set-up Time	2.3		2.5		2.5		3.0		ns
t _{HB}	Byte Select Hold Time	0.6		0.6		0.6		0.6		ns
t _{SC}	Chip Enable Set-up Time	2.3		2.5		NA		NA		ns
t _{HC}	Chip Enable Hold Time	0.6		0.6		NA		NA		ns
t _{SW}	R/W Set-up Time	2.3		2.5		2.5		3.0		ns
t _{HW}	R/W Hold Time	0.6		0.6		0.6		0.6		ns
t _{SD}	Input Data Set-up Time	2.3		2.5		2.5		3.0		ns
t _{HD}	Input Data Hold Time	0.6		0.6		0.6		0.6		ns
t _{SAD}	ADS Set-up Time	2.3		2.5		NA		NA		ns
t _{HAD}	ADS Hold Time	0.6		0.6		NA		NA		ns
t _{SCN}	CNTEN Set-up Time	2.3		2.5		NA		NA		ns
t _{HCN}	CNTEN Hold Time	0.6		0.6		NA		NA		ns
t _{SRST}	CNTRST Set-up Time	2.3		2.5		NA		NA		ns
t _{HRST}	CNTRST Hold Time	0.6		0.6		NA		NA		ns
t _{SCM}	CNT/MSK Set-up Time	2.3		2.5		NA		NA		ns
t _{HCM}	CNT/MSK Hold Time	0.6		0.6		NA		NA		ns

Note:

19. Except JTAG signals (t_r and $t_f < 10$ ns [max.]).



Switching Characteristics Over the Operating Range (continued)

		-1	67		-1	33		-1	00	
		CY7C	850AV 851AV 852AV	CY7CC)850AV)851AV)852AV	CY7C)853AV	СҮ7СС)853AV	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
t _{OE}	Output Enable to Data Valid		4.0		4.4		4.7		5.0	ns
t _{OLZ} [20, 21]	OE to Low Z	0		0		0		0		ns
t _{OHZ} [20, 21]	OE to High Z	0	4.0	0	4.4	0	4.7	0	5.0	ns
t _{CD2}	Clock to Data Valid		4.0		4.4		4.7		5.0	ns
t _{CA2}	Clock to Counter Address Valid		4.0		4.4		NA		NA	ns
t _{CM2}	Clock to Mask Register Readback Valid		4.0		4.4		NA		NA	ns
t _{DC}	Data Output Hold After Clock HIGH	1.0		1.0		1.0		1.0		ns
t _{CKHZ} [20, 21]	Clock HIGH to Output High Z	0	4.0	0	4.4	0	4.7	0	5.0	ns
t _{CKLZ} [20, 21]	Clock HIGH to Output Low Z	1.0	4.0	1.0	4.4	1.0	4.7	1.0	5.0	ns
t _{SINT}	Clock to INT Set Time	0.5	6.7	0.5	7.5	0.5	7.5	0.5	10	ns
t _{RINT}	Clock to INT Reset Time	0.5	6.7	0.5	7.5	0.5	7.5	0.5	10	ns
t _{SCINT}	Clock to CNTINT Set Time	0.5	5.0	0.5	5.7	NA	NA	NA	NA	ns
t _{RCINT}	Clock to CNTINT Reset time	0.5	5.0	0.5	5.7	NA	NA	NA	NA	ns
Port to Por	t Delays									
t _{ccs}	Clock to Clock Skew	5.2		6.0		6.0		8.0		ns
Master Res	et Timing									
t _{RS}	Master Reset Pulse Width	7.0		7.5		7.5		10.0		ns
t _{RSS}	Master Reset Set-up Time	6.0		6.0		6.0		8.5		ns
t _{RSR}	Master Reset Recovery Time	6.0		7.5		7.5		10.0		ns
t _{RSF}	Master Reset to Outputs Inactive		10.0		10.0		10.0		10.0	ns
t _{RSCNTINT}	Master Reset to Counter Interrupt Flag Reset Time		10.0		10.0		NA		NA	ns

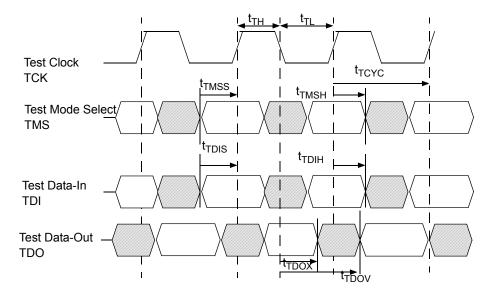
Notes: 20. This parameter is guaranteed by design, but it is not production tested. 21. Test conditions used are Load 2.



JTAG Timing

		167/13	33/100	
Parameter	Description	Min.	Max.	Unit
f _{JTAG}	Maximum JTAG TAP Controller Frequency		10	MHz
t _{TCYC}	TCK Clock Cycle Time	100		ns
t _{TH}	TCK Clock HIGH Time	40		ns
t _{TL}	TCK Clock LOW Time	40		ns
t _{TMSS}	TMS Set-up to TCK Clock Rise	10		ns
t _{TMSH}	TMS Hold After TCK Clock Rise	10		ns
t _{TDIS}	TDI Set-up to TCK Clock Rise	10		ns
t _{TDIH}	TDI Hold After TCK Clock Rise	10		ns
t _{TDOV}	TCK Clock LOW to TDO Valid		30	ns
t _{TDOX}	TCK Clock LOW to TDO Invalid	0		ns

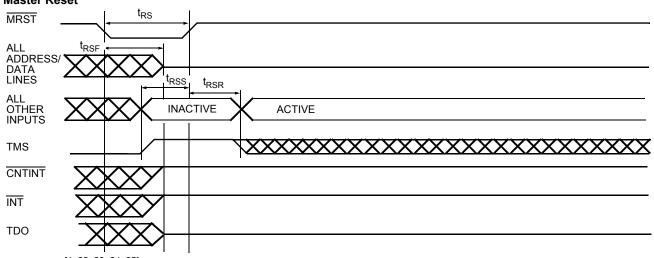
JTAG Switching Waveform



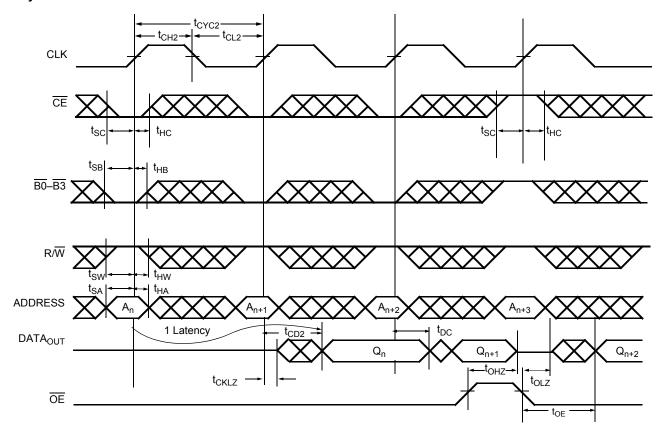


Switching Waveforms





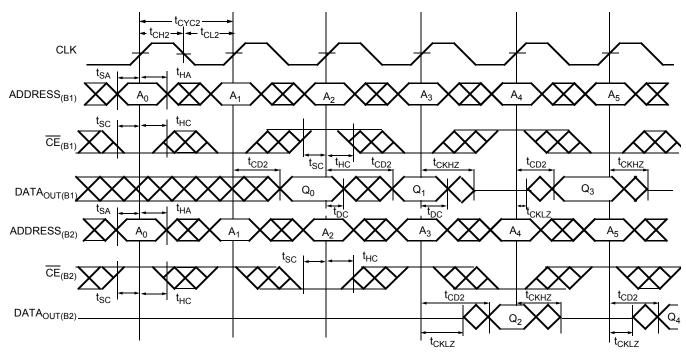
Read Cycle^[4, 22, 23, 24, 25]



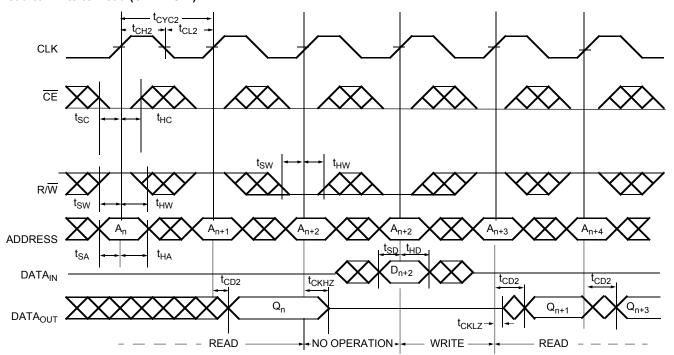
<sup>Notes:
22. OE is asynchronously controlled; all other inputs (excluding MRST and JTAG) are synchronous to the rising clock edge.
23. ADS = CNTEN = LOW, and MRST = CNTRST = CNT/MSK = HIGH.
24. The output is disabled (high-impedance state) by CE = V_{IL} following the next rising edge of the clock.
25. Addresses do not have to be accessed sequentially since ADS = CNTEN = V_{IL} with CNT/MSK = V_{IH} constantly loads the address on the rising edge of the CLK. Numbers are for reference only.</sup>



Bank Select Read^[26, 27]



Read-to-Write-to-Read (OE = LOW)^[25, 28, 29, 30, 31]



Notes:

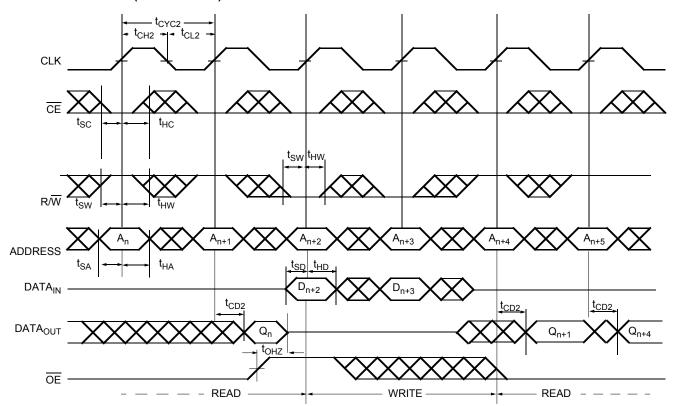
26. In this depth-expansion example, B1 represents Bank #1 and B2 is Bank #2; each bank consists of one Cypress CY7C0851AV/CY7C0852AV device from this data sheet. ADDRESS_(B1) = ADDRESS_(B2).

27. $\overline{ADS} = \overline{CNTEN} = \overline{B0} - \overline{B3} = \overline{OE} = LOW; \overline{MRST} = \overline{CNTRST} = CNT/\overline{MSK} = HIGH.$ 28. Output state (HIGH, LOW, or high-impedance) is determined by the previous cycle control signals.

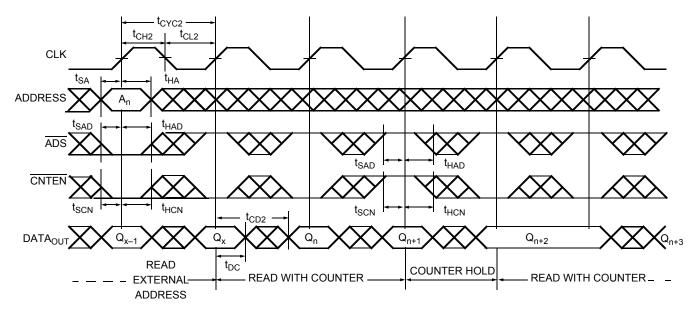
29. During "No Operation," data in memory at the selected address may be corrupted and should be rewritten to ensure data integrity.
 29. During "No Operation," data in memory at the selected address may be corrupted and should be rewritten to ensure data integrity.
 31. CE₀ = OE = B0 - B3 = LOW; CE₁ = R/W = CNTRST = MRST = HIGH.
 31. CE₀ = B0 - B3 = R/W = LOW; CE₁ = CNTRST = MRST = CNT/MSK = HIGH. When R/W first switches low, since OE = LOW, the Write operation cannot be completed (labelled as no operation). One clock cycle is required to three-state the I/O for the Write operation on the next rising edge of CLK.



Read-to-Write-to-Read (OE Controlled)^[25, 28, 30, 31]

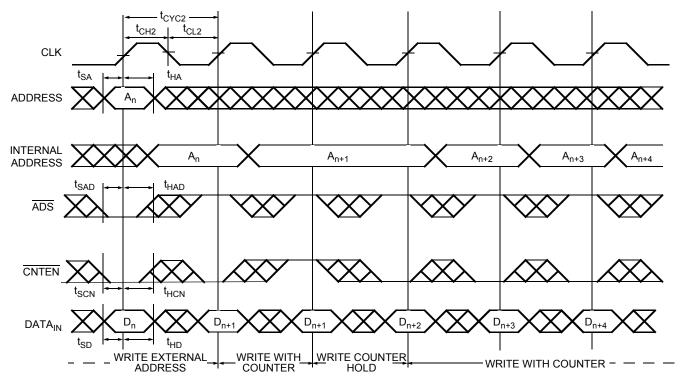


Read with Address Counter Advance^[30]

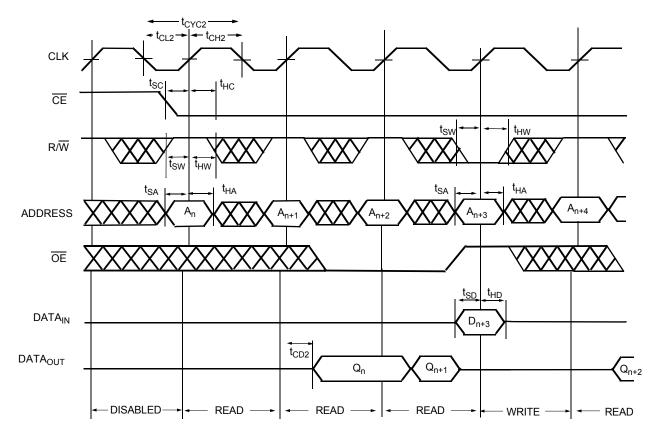




Write with Address Counter Advance [31]

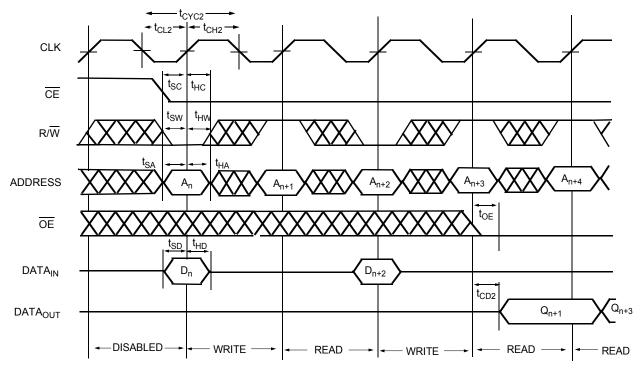


Disabled-to-Read-to-Read-to-Write

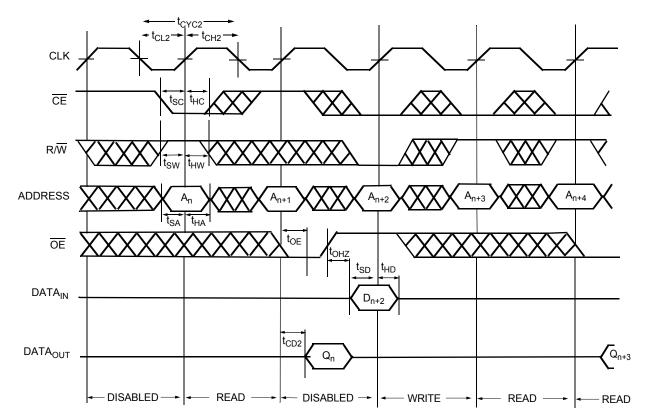




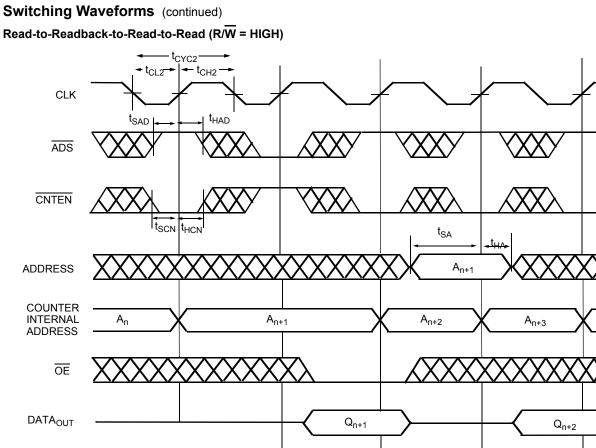




Disabled-to-Read-to-Disabled-to-Write







→ → NO OPERATION •

READBACK

READ -

INCREMENT

*

INCREMENT

READ —

INCREMENT

 A_{n+4}

Q_{n+3}

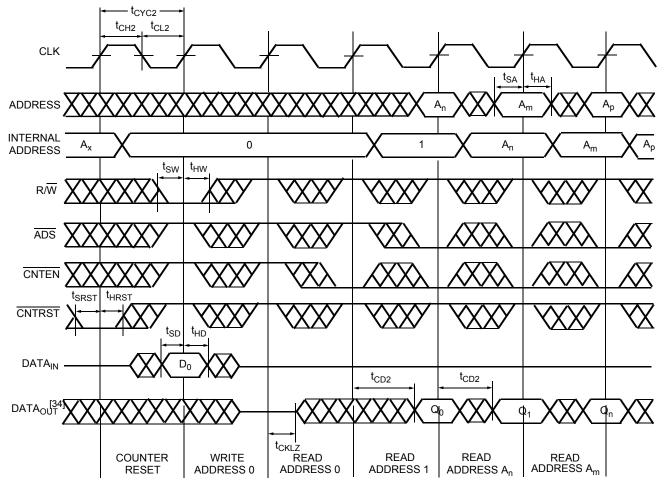
- READ

INCREMENT

READ



Counter Reset^[32, 33]



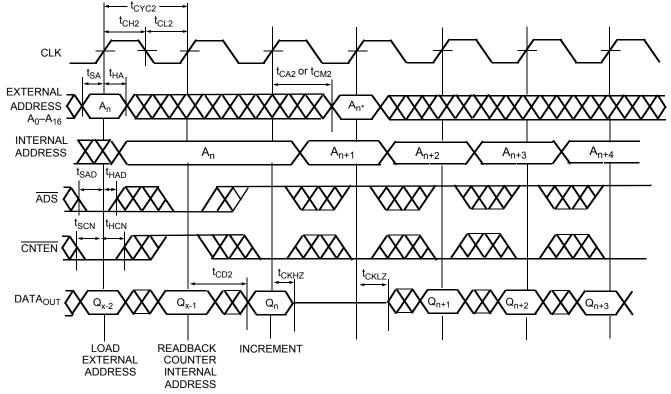
Notes:

 $32.CE_0 = \overline{B0} - \overline{B3} = LOW; CE_1 = \overline{MRST} = CNT/\overline{MSK} = HIGH.$ 33. No dead cycle exists during counter reset. A Read or Write cycle may be coincidental with the counter reset.

34. Retransmit happens if the counter remains in increment mode after it wraps to initially loaded value.



Readback State of Address Counter or Mask Register^[35, 36, 37, 38]



Notes:

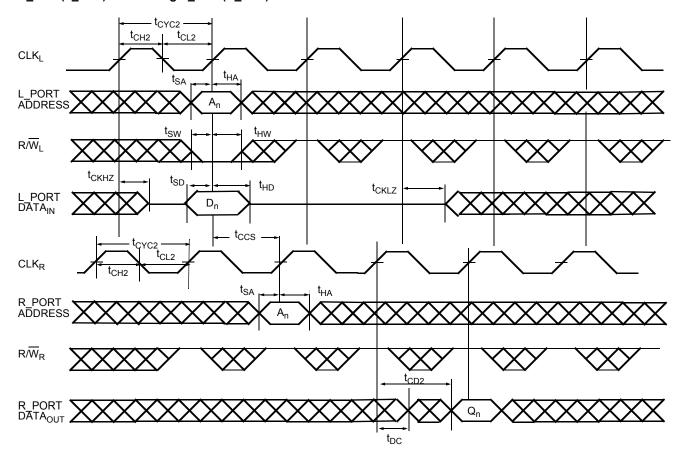
35. $\overline{CE}_0 = \overline{OE} = \overline{B0} - \overline{B3} = LOW$; $CE_1 = R/\overline{W} = \overline{CNTRST} = \overline{MRST} = HIGH$.

36. Address in output mode. Host must not be driving address bus after t_{CKLZ} in next clock cycle.

37. Address in input mode. Host can drive address bus after t_{CKHZ}.
 38. An * is the internal value of the address counter (or the mask register depending on the CNT/MSK level) being Read out on the address lines.



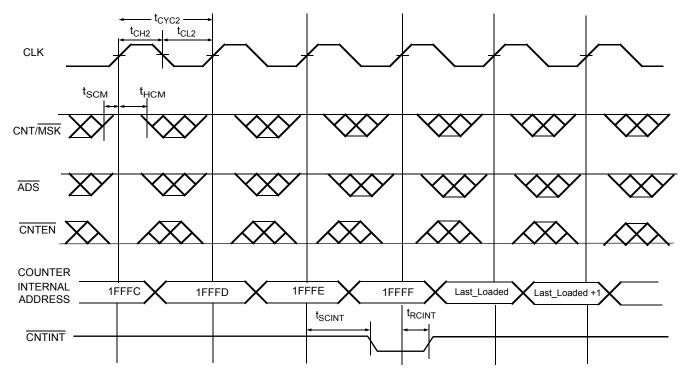
Left_Port (L_Port) Write to Right_Port (R_Port) Read^[39, 40, 41]

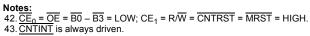


Notes: 39. $CE_0 = \overline{OE} = \overline{ADS} = \overline{CNTEN} = \overline{B0} - \overline{B3} = LOW$; $CE_1 = \overline{CNTRST} = \overline{MRST} = CNT/\overline{MSK} = HIGH$. 40. This timing is valid when one port is writing, and other port is reading the same location at the same time. If t_{CCS} is violated, indeterminate data will be Read out. 41. If $t_{CCS} <$ minimum specified value, then R_Port will Read the most recent data (written by L_Port) only (2 * $t_{CYC2} + t_{CD2}$) after the rising edge of R_Port's clock. If $t_{CCS} ≥$ minimum specified value, then R_Port will Read the most recent data (written by L_Port) ($t_{CYC2} + t_{CD2}$) after the rising edge of R_Port's clock. If $t_{CCS} ≥$ minimum specified value, then R_Port will Read the most recent data (written by L_Port) ($t_{CYC2} + t_{CD2}$) after the rising edge of R_Port's clock.



Counter Interrupt and Retransmit^[34, 42, 43, 44, 45]





44. CNTINT goes LOW when the unmasked portion of the address counter is incremented to the maximum value.

45. The mask register assumed to have the value of 1FFFFh.



MailBox Interrupt Timing^[46, 47, 48, 49, 50]

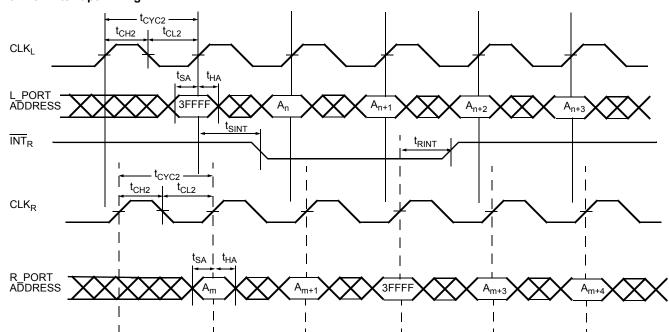


Table 7. Read/Write and Enable Operation (Any Port)^[1, 8, 51, 52]

		Inputs			Outputs	
OE	CLK	CE0	CE ₁	R/W	$DQ_0 - DQ_{35}$	Operation
Х		Н	Х	Х	High-Z	Deselected
Х		Х	L	Х	High-Z	Deselected
х		L	Н	L	D _{IN}	Write
L		L	Н	Н	D _{OUT}	Read
Н	Х	L	Н	Х	High-Z	Outputs Disabled

Notes:

46. $\overline{CE}_0 = \overline{OE} = \overline{ADS} = \overline{CNTEN} = LOW; CE_1 = \overline{CNTRST} = \overline{MRST} = CNT/\overline{MSK} = HIGH.$

47. Address "3FFFF" is the mailbox location for R_Port of a 9M device.

48. L_Port is configured for Write operation, and \overline{R} Port is configured for Read operation. 49. At least one byte enable ($\overline{B0} - \overline{B3}$) is required to be active during interrupt operations.

50. Interrupt flag is set with respect to the rising edge of the Write clock, and is reset with respect to the rising edge of the Read clock.

51. OE is an asynchronous input signal.

52. When CE changes state, deselection and Read happen after one cycle of latency.



Ordering Information

256K × 36 (9M) 3.3V Synchronous CY7C0853AV Dual-Port SRAM

Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
133	CY7C0853AV-133BBC	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Commercial
	CY7C0853AV-133BBI	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Industrial
100	CY7C0853AV-100BBC	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Commercial
	CY7C0853AV-100BBI	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Industrial

128K × 36 (4M) 3.3V Synchronous CY7C0852AV Dual-Port SRAM

Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
167	CY7C0852AV-167BBC	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Commercial
	CY7C0852AV-167AC	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Commercial
133	CY7C0852AV-133BBC	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Commercial
	CY7C0852AV-133BBI	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Industrial
	CY7C0852AV-133AC	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Commercial
	CY7C0852AV-133AI	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Industrial

64K × 36 (2M) 3.3V Synchronous CY7C0851AV Dual-Port SRAM

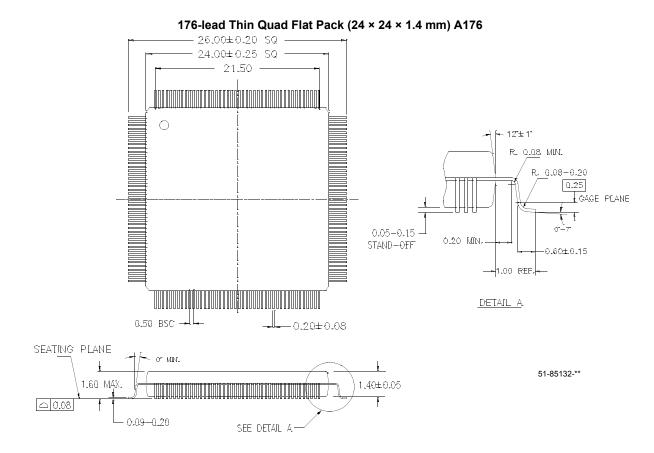
Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
167	CY7C0851AV-167BBC	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Commercial
	CY7C0851AV-167AC	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Commercial
133	CY7C0851AV-133BBC	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Commercial
	CY7C0851AV-133BBI	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Industrial
	CY7C0851AV-133AC	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Commercial
	CY7C0851AV-133AI	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Industrial

32K × 36 (1M) 3.3V Synchronous CY7C0850AV Dual-Port SRAM

Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
167	CY7C0850AV-167BBC	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Commercial
	CY7C0850AV-167AC	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Commercial
133	CY7C0850AV-133BBC	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Commercial
	CY7C0850AV-133BBI	BB172	172-ball Grid Array 15 mm × 15 mm with 1.0-mm pitch (BGA)	Industrial
	CY7C0850AV-133AC	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Commercial
	CY7C0850AV-133AI	A176	176-pin Flat Pack 24 mm × 24 mm (TQFP)	Industrial

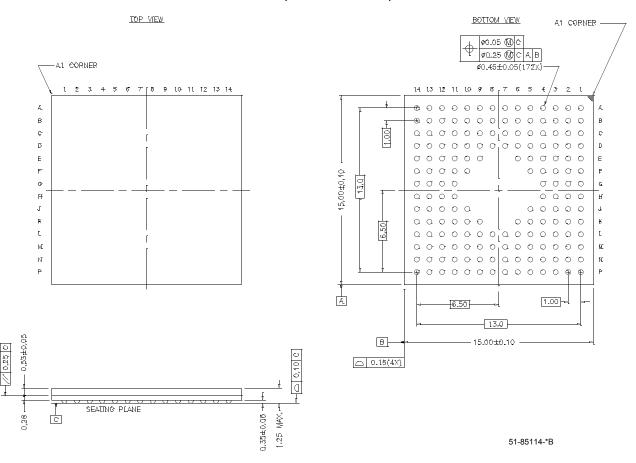


Package Diagrams





Package Diagrams (continued)



172-Ball FBGA (15 x 15 x 1.25 mm) BB172

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Document History Page

REV.ECN NO.Issue DateOrig. of ChangeDescription of Change**12780908/04/03SPNThis data sheet has been extracted from an data sheet. The following changes have b pertains to this device: Updated capacitance values Updated "Read-to-Write-to-Read (OE Cor Revised static discharge voltage Corrected 0853 pins L3 and L12 Added discussion of Pause/Restart for JT/ Power up requirements added to Maximum Revise tcd2, tOE, tOHZ, tCKHZ, tCKLZ for the or Updated 133-MHZ Industrial device to Order*A210948See ECNYDTChanged mailbox addresses from 1FFFE a s reading that location." from Functional D	een made from the original as trolled)" waveform AG boundary scan n Ratings information CY7C0853V to 4.7 ns ing Information table nd 1FFFF to 3FFFE and 3FFFF
12780908/04/03SPNThis data sheet has been extracted normal data sheet. The following changes have b pertains to this device: Updated capacitance values Updated "Read-to-Write-to-Read (OE Cor Revised static discharge voltage Corrected 0853 pins L3 and L12 Added discussion of Pause/Restart for JT/ Power up requirements added to Maximum Revise tcd2, toE, toHz, tcKHz, tcKLz for the Updated lcc numbers Updated tHA, tHB, tHD for -100 speed Separated out from the 4M data sheet Added 133-MHz Industrial device to Order*A210948See ECNYDTChanged mailbox addresses from 1FFFE a is reading that location." from Functional E	een made from the original as trolled)" waveform AG boundary scan n Ratings information CY7C0853V to 4.7 ns ing Information table nd 1FFFF to 3FFFE and 3FFFF
*B 216190 See ECN YDT/Dcon Corrected Revision of Document. CMS do *C 231996 See ECN YDT Removed "A particular port can write to a ce is reading that location." from Functional E	
*C 231996 See ECN YDT Removed "A particular port can write to a ce is reading that location." from Functional E	es not reflect this rev change
is reading that location." from Functional E	ee net reneet and rev enange
	rtain location while another port rescription.
*D 238938 See ECN WWZ Merged 0853 (9Mx36) with 0852 (4Mx36) a x36), to the data sheet. Added product selection table. Added JTAG ID code for 1M device. Added note 14. Updated boundary scan section. Updated function description for the merger	
*E 329122 See ECN SPN Updated Marketing part numbers	
*F 389877 See ECN KGH Updated Read-to-Write-to-Read timing dia turnaround scheme. Added I _{SB5} Changed t _{RSCNTINT} to 10ns Changed t _{RSF} to 10ns Added figure Disabled-to-Read-to-Read-to Added figure Disabled-to-Read-to-Disable Added figure Read-to-Read-to-Disable Added figure Read-to-Read-to-Read-to-Read- Updated Read-to-Write-to-Read timing dia schemes Updated Disabled-to-Read-to-Read-to-Re Correct the chip enable, data in, and data of Updated Disabled-to-Read-to-Write-to-Rea	-Read-to-Write -Write-to-Read d-to-Writeto-Read (R/W = HIGH) gram to correct the data out ad-to-Write timing diagram to but schemes te-to-Read timing diagram to schemes Write timing diagram to correct
*G 391597 See ECN SPN Updated counter reset section to reflect m	